

**$V_{DRM}$**  = 2800 V  
 **$I_{T(AV)M}$**  = 5080 A  
 **$I_{T(RMS)}$**  = 7970 A  
 **$I_{TSM}$**  =  $75 \times 10^3$  A  
 **$V_{TO}$**  = 0.86 V  
 **$r_T$**  = 0.07 mW

# Phase Control Thyristor

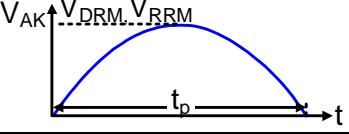
**5STP 45N2800**

Doc. No. 5SYA1007-04 May 07

- Patented free-floating silicon technology
- Low on-state and switching losses
- Designed for traction, energy and industrial applications
- Optimum power handling capability
- Interdigitated amplifying gate

## Blocking

Maximum rated values <sup>1)</sup>

Parameter	Symbol	Conditions	5STP 45N2800		Unit
Max repetitive peak forward and reverse blocking voltage	$V_{DRM}$ , $V_{RRM}$	$f = 50$ Hz, $t_p = 10$ ms, $T_{vj} = 5 \dots 125^\circ\text{C}$ , Note 1	2800		V
					
Critical rate of rise of commutating voltage	$dv/dt_{crit}$	Exp. to 1880 V, $T_{vj} = 125^\circ\text{C}$	1000		V/ $\mu$ s

Characteristic values

Parameter	Symbol	Conditions	min	typ	max	Unit
Forward leakage current	$I_{DRM}$	$V_{DRM}$ , $T_{vj} = 125^\circ\text{C}$			400	mA
Reverse leakage current	$I_{RRM}$	$V_{RRM}$ , $T_{vj} = 125^\circ\text{C}$			400	mA

Note 1: Voltage de-rating factor of 0.11% per  $^\circ\text{C}$  is applicable for  $T_{vj}$  below  $+5^\circ\text{C}$

## Mechanical data

Maximum rated values <sup>1)</sup>

Parameter	Symbol	Conditions	min	typ	max	Unit
Mounting force	$F_M$		81	90	108	kN
Acceleration	a	Device unclamped			50	$\text{m/s}^2$
Acceleration	a	Device clamped			100	$\text{m/s}^2$

Characteristic values

Parameter	Symbol	Conditions	min	typ	max	Unit
Weight	m				2.9	kg
Housing thickness	H	$F_M = 90$ kN, $T_a = 25^\circ\text{C}$	34.4		35	mm
Surface creepage distance	$D_s$		56			mm
Air strike distance	$D_a$		22			mm

1) Maximum rated values indicate limits beyond which damage to the device may occur

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## On-state

### Maximum rated values <sup>1)</sup>

Parameter	Symbol	Conditions	min	typ	max	Unit
Average on-state current	$I_{T(AV)M}$	Half sine wave, $T_c = 70^\circ C$			5080	A
RMS on-state current	$I_{T(RMS)}$				7970	A
Peak non-repetitive surge current	$I_{TSM}$	$t_p = 10 \text{ ms}, T_{vj} = 125^\circ C, \text{sine wave}$ $\text{after surge: } V_D = V_R = 0 \text{ V}$			$75 \times 10^3$	A
Limiting load integral	$I^2t$				$28.1 \times 10^6$	$A^2\text{s}$
Peak non-repetitive surge current	$I_{TSM}$	$t_p = 8.3 \text{ ms}, T_{vj} = 125^\circ C, \text{sine wave}$ $\text{after surge: } V_D = V_R = 0 \text{ V}$			$79 \times 10^3$	A
Limiting load integral	$I^2t$				$25.9 \times 10^6$	$A^2\text{s}$

### Characteristic values

Parameter	Symbol	Conditions	min	typ	max	Unit
On-state voltage	$V_T$	$I_T = 3000 \text{ A}, T_{vj} = 125^\circ C$			1.07	V
Threshold voltage	$V_{(TO)}$	$I_T = 3000 \text{ A} - 9000 \text{ A}, T_{vj} = 125^\circ C$			0.86	V
Slope resistance	$r_T$				0.07	$m\Omega$
Holding current	$I_H$	$T_{vj} = 25^\circ C$ $T_{vj} = 125^\circ C$			100	$mA$
Latching current	$I_L$				75	$mA$
		$T_{vj} = 25^\circ C$ $T_{vj} = 125^\circ C$			500	$mA$
					350	$mA$

## Switching

### Maximum rated values <sup>1)</sup>

Parameter	Symbol	Conditions	min	typ	max	Unit
Critical rate of rise of on-state current	$di/dt_{crit}$	$T_{vj} = 125^\circ C,$ $I_{TRM} = 3000 \text{ A},$ $f = 50 \text{ Hz}$			250	$A/\mu s$
Critical rate of rise of on-state current	$di/dt_{crit}$				1000	$A/\mu s$
Circuit-commutated turn-off time	$t_q$	$T_{vj} = 125^\circ C, I_{TRM} = 2000 \text{ A},$ $V_R = 200 \text{ V}, di_T/dt = -1.5 \text{ A}/\mu s,$ $V_D \leq 0.67 \cdot V_{DRM}, dv_D/dt = 20 \text{ V}/\mu s$	400			$\mu s$

### Characteristic values

Parameter	Symbol	Conditions	min	typ	max	Unit
Reverse recovery charge	$Q_{rr}$	$T_{vj} = 125^\circ C, I_{TRM} = 2000 \text{ A},$ $V_R = 200 \text{ V},$ $di_T/dt = -1.5 \text{ A}/\mu s$	1200		3800	$\mu As$
Reverse recovery current	$I_{RM}$		30		100	A
Gate turn-on delay time	$t_{gd}$	$T_{vj} = 25^\circ C, V_D = 0.4 \cdot V_{RM}, I_{FG} = 2 \text{ A},$ $t_r = 0.5 \mu s$			3	$\mu s$

## Triggering

*Maximum rated values<sup>1)</sup>*

Parameter	Symbol	Conditions	min	typ	max	Unit
Peak forward gate voltage	$V_{FGM}$				12	V
Peak forward gate current	$I_{FGM}$				10	A
Peak reverse gate voltage	$V_{RGM}$				10	V
Average gate power loss	$P_{G(AV)}$		see Fig. 9			W

*Characteristic values*

Parameter	Symbol	Conditions	min	typ	max	Unit
Gate-trigger voltage	$V_{GT}$	$T_{vj} = 25^\circ C$			2.6	V
Gate-trigger current	$I_{GT}$	$T_{vj} = 25^\circ C$			400	mA
Gate non-trigger voltage	$V_{GD}$	$V_D = 0.4 \times V_{DRM}, T_{vj} = 125^\circ C$	0.3			V
Gate non-trigger current	$I_{GD}$	$V_D = 0.4 \times V_{DRM}, T_{vj} = 125^\circ C$	10			mA

## Thermal

*Maximum rated values<sup>1)</sup>*

Parameter	Symbol	Conditions	min	typ	max	Unit
Operating junction temperature range	$T_{vj}$				125	°C
Storage temperature range	$T_{stg}$		-40		140	°C

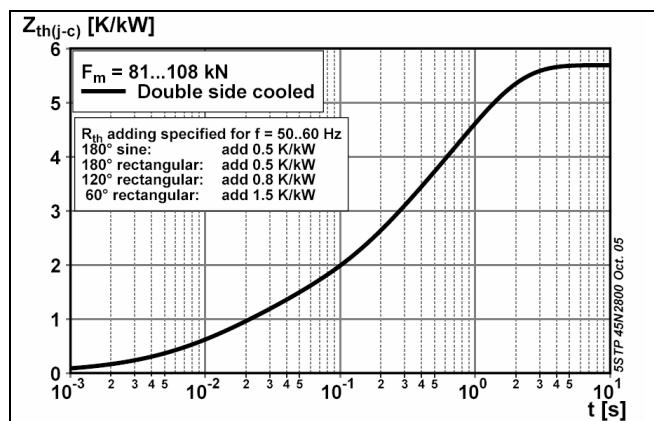
*Characteristic values*

Parameter	Symbol	Conditions	min	typ	max	Unit
Thermal resistance junction to case	$R_{th(j-c)}$	Double-side cooled $F_m = 81...108$ kN			5.7	K/kW
	$R_{th(j-c)A}$	Anode-side cooled $F_m = 81...108$ kN			11.4	K/kW
	$R_{th(j-c)C}$	Cathode-side cooled $F_m = 81...108$ kN			11.4	K/kW
Thermal resistance case to heatsink	$R_{th(c-h)}$	Double-side cooled $F_m = 81...108$ kN			1	K/kW
	$R_{th(c-h)}$	Single-side cooled $F_m = 81...108$ kN			2	K/kW

**Analytical function for transient thermal impedance:**

$$Z_{th(j-c)}(t) = \sum_{i=1}^n R_i (1 - e^{-t/\tau_i})$$

i	1	2	3	4
$R_i(K/kW)$	3.400	1.260	0.680	0.350
$\tau_i(s)$	0.8685	0.1572	0.0219	0.0078



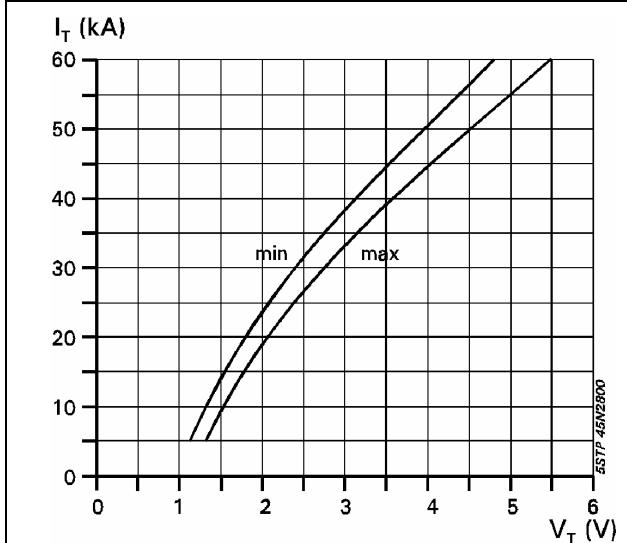
**Fig. 1** Transient thermal impedance (junction-to-case) vs. time

**On-state characteristic model:**

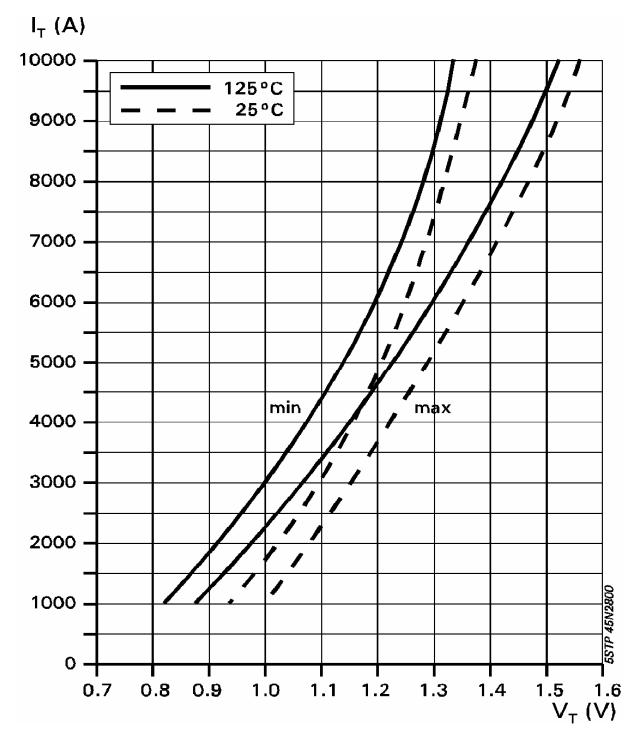
$$V_{T\max} = A + B \cdot I_T + C \cdot \ln(I_T + 1) + D \cdot \sqrt{I_T}$$

Valid for  $I_T = 500 - 15000$  A

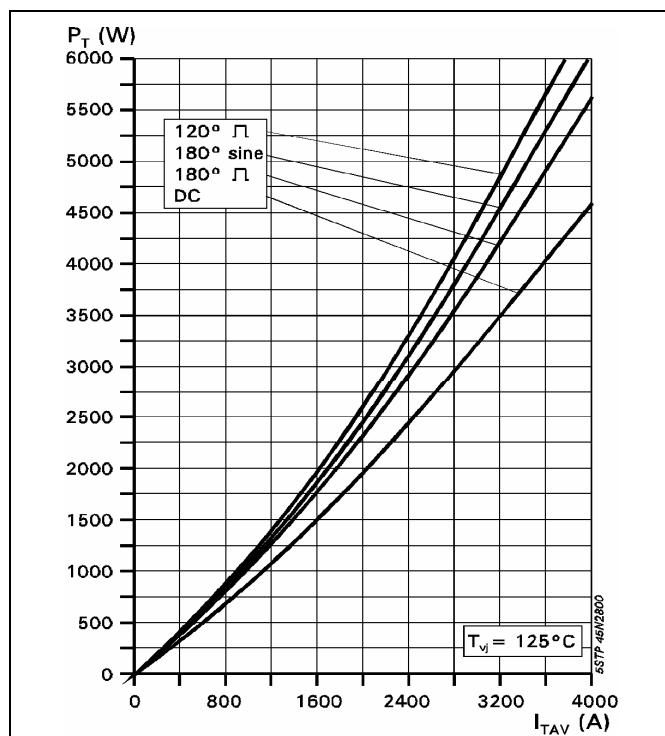
A	B	C	D
$-96.29 \times 10^{-3}$	$51.0 \times 10^{-6}$	$135.7 \times 10^{-3}$	$-1.358 \times 10^{-3}$



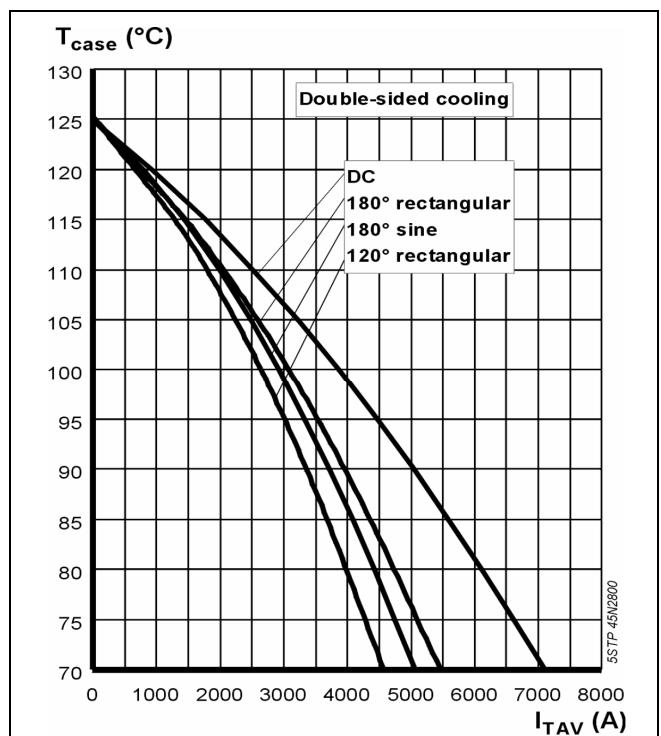
**Fig. 2** On-state characteristics,  
 $T_j=125^\circ\text{C}$ , 10ms half sine



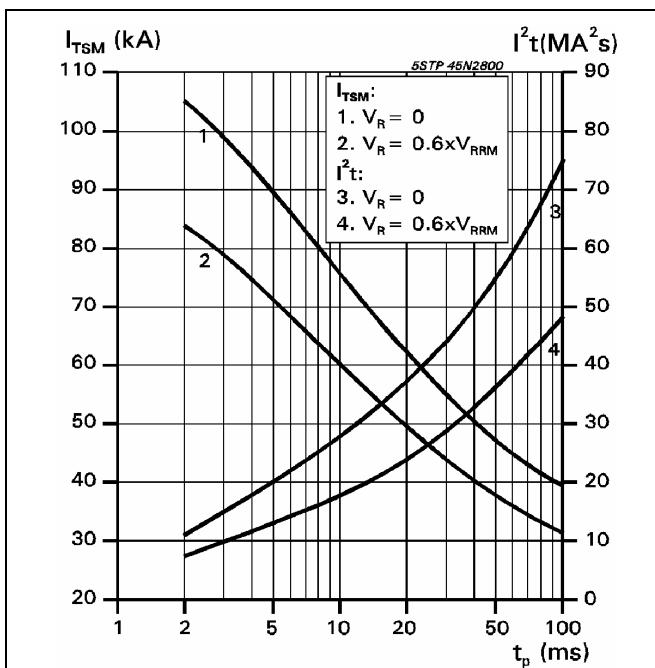
**Fig. 3** On-state voltage characteristics



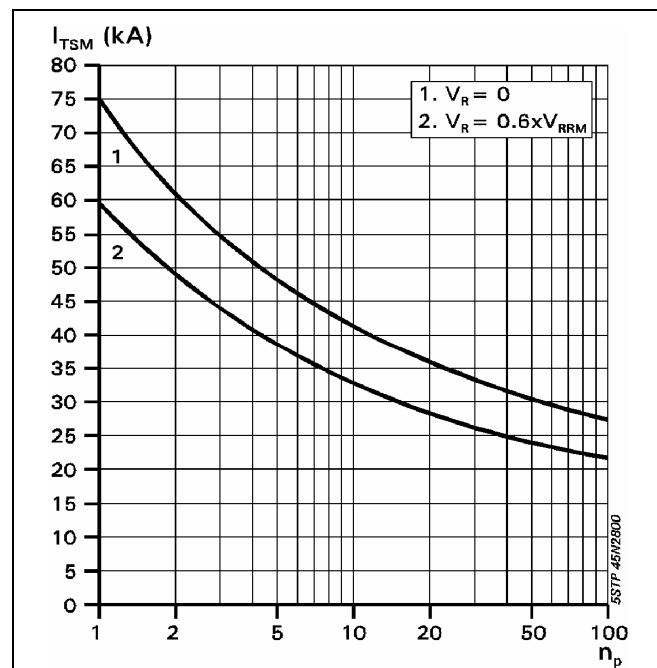
**Fig. 4** On-state power dissipation vs. mean on-state current, turn-on losses excluded



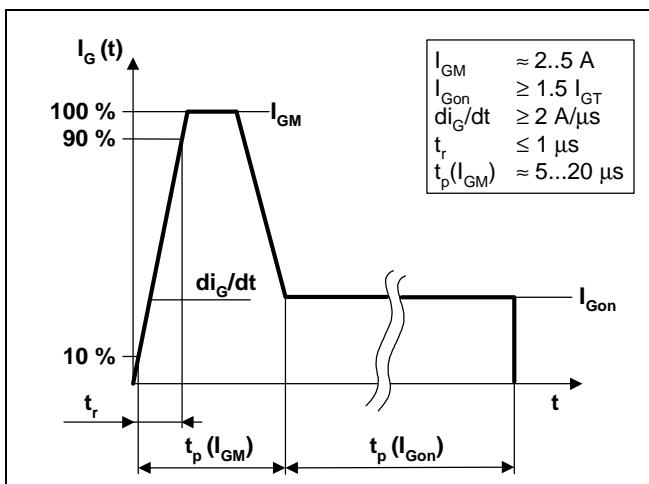
**Fig. 5** Max. permissible case temperature vs. mean on-state current, switching losses ignored



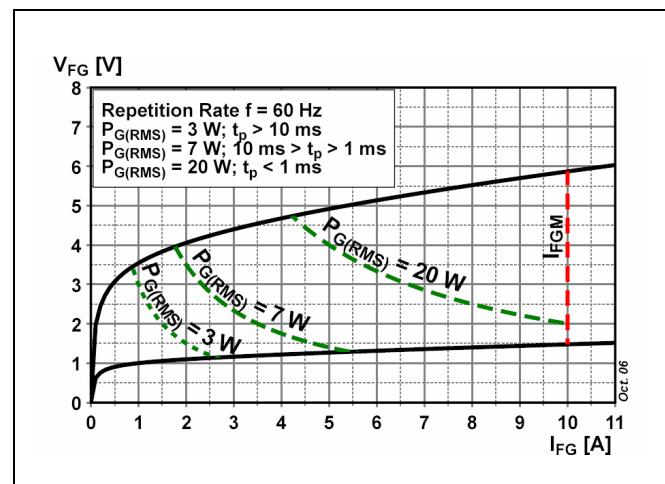
**Fig. 6** Surge on-state current vs. pulse length, half-sine wave



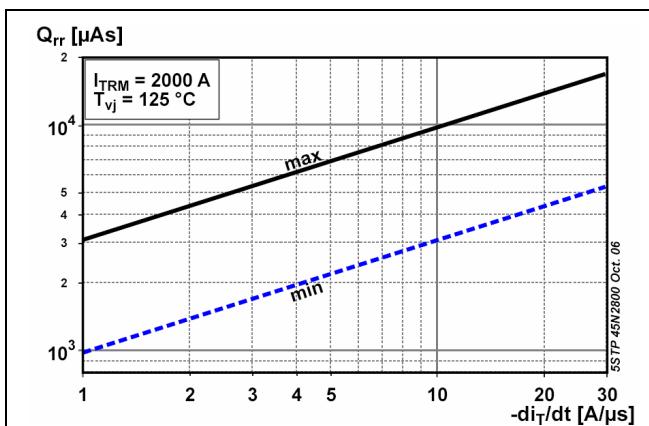
**Fig. 7** Surge on-state current vs. number of pulses, half-sine wave, 10 ms, 50Hz



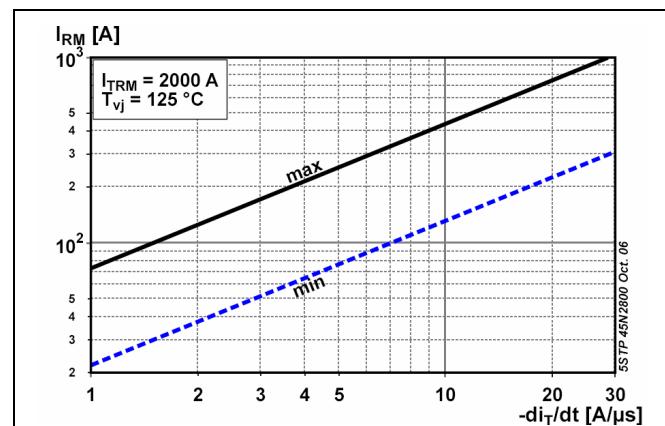
**Fig. 8** Recommended gate current waveform



**Fig. 9** Max. peak gate power loss

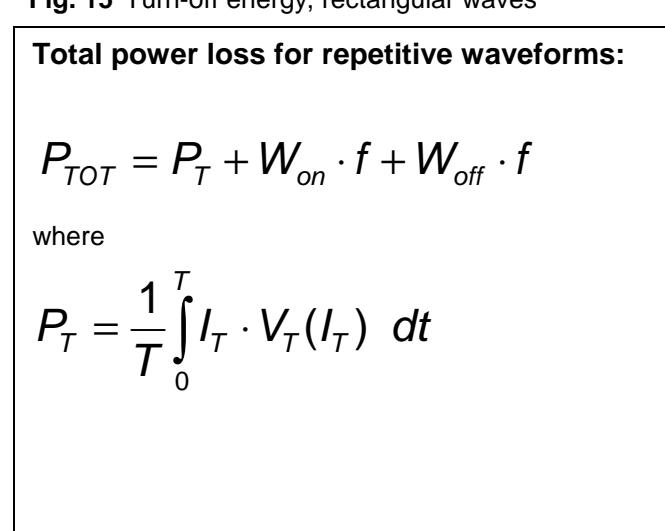
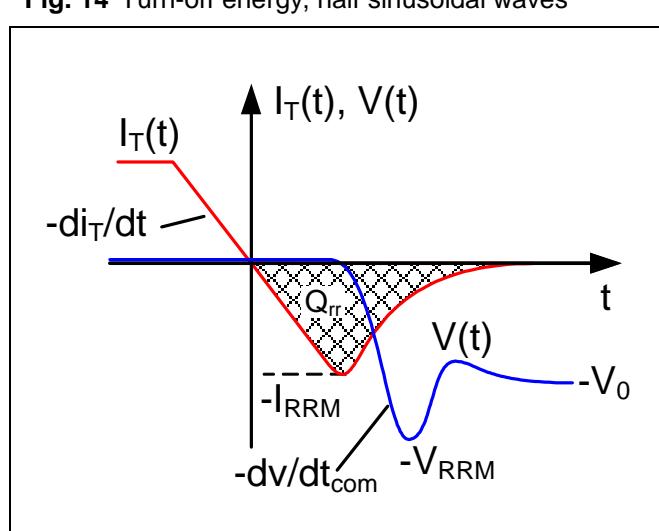
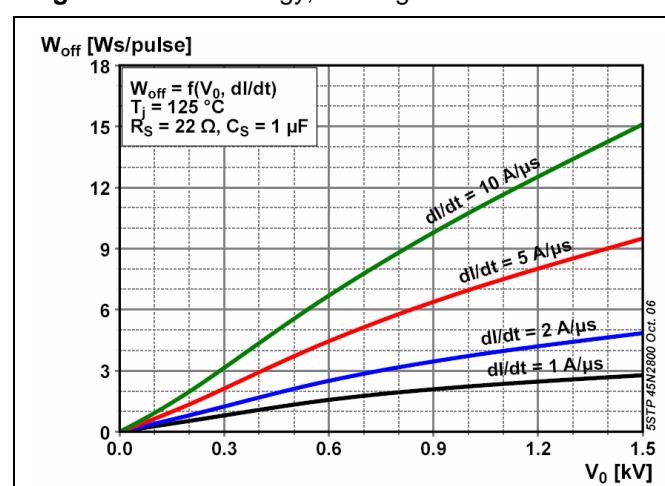
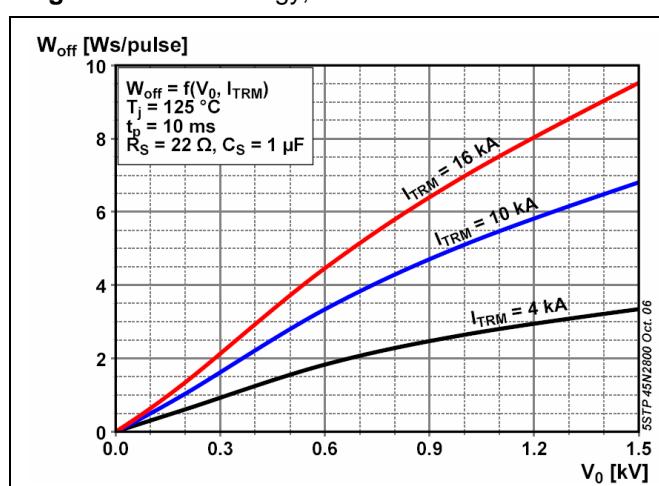
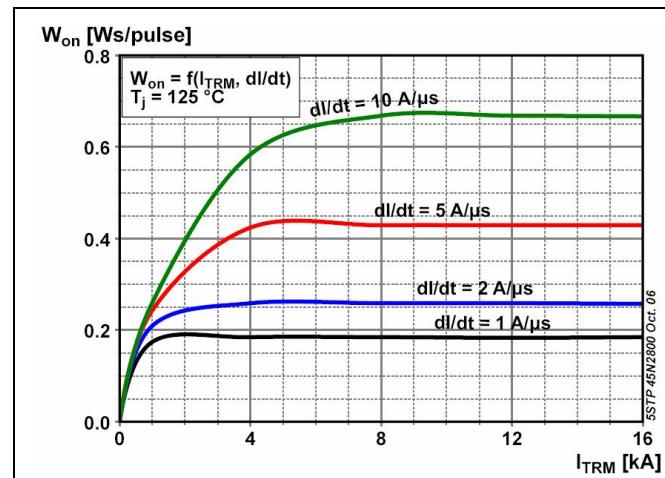
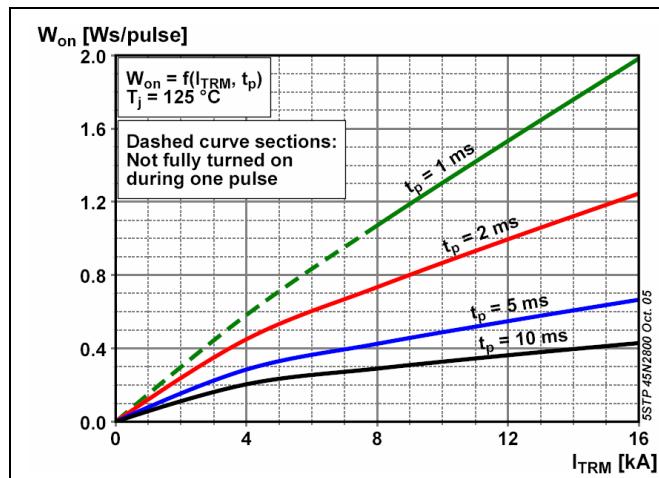


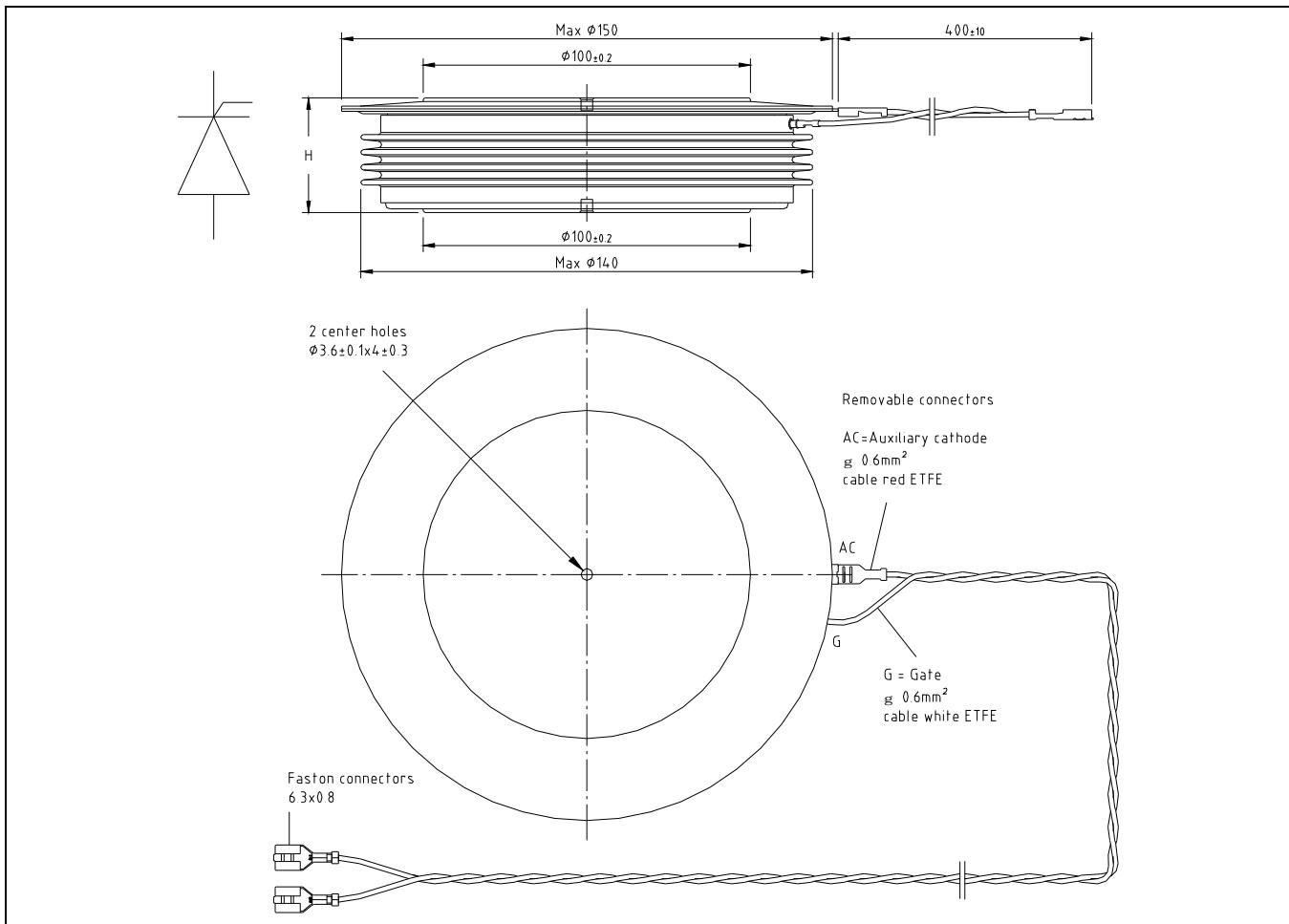
**Fig. 10** Reverse recovery charge vs. decay rate of on-state current



**Fig. 11** Peak reverse recovery current vs. decay rate of on-state current

## Turn-on and Turn-off losses





**Fig. 18** Device Outline Drawing

### Related documents:

- 5SYA 2020 Design of RC-Snubber for Phase Control Applications
- 5SYA 2049 Voltage definitions for phase control thyristors and diodes
- 5SYA 2051 Voltage ratings of high power semiconductors
- 5SYA 2034 Gate-Drive Recommendations for PCT's
- 5SYA 2036 Recommendations regarding mechanical clamping of Press Pack High Power Semiconductors
- 5SZK 9104 Specification of environmental class for pressure contact diodes, PCTs and GTO, STORAGE available on request, please contact factory
- 5SZK 9105 Specification of environmental class for pressure contact diodes, PCTs and GTO, TRANSPORTATION available on request, please contact factory

Please refer to <http://www.abb.com/semiconductors> for current version of documents.

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